Docket No. END920020084US2 (EN-10-5695-D1)

## **APPLICATION DATA SHEET**

#### INVENTOR INFORMATION::

Inventor One Given Name:: William Family Name:: Infantolino

Postal Address Line One:: 481 Echo Road

City:: Vestal
State or Province:: New York
Postal or Zip Code:: 13850

Citizenship Country:: United States

Inventor Two Given Name:: Voya R. Family Name:: Markovich

Postal Address Line One:: 3611 Joel Drive

City:: Endwell
State or Province:: New York
Postal or Zip Code:: 13760

Citizenship Country:: United States

Inventor Three Given Name:: Sanjeev B. Family Name:: Sathe

Postal Address Line One:: 1224 Cherese Lane

City:: Binghamton
State or Province:: New York
Postal or Zip Code:: 13905

Citizenship Country:: United States

Inventor Four Given Name:: George H.

Family Name:: Thiel

Postal Address Line One:: 1117 Ivon Avenue

City:: Endicott
State or Province:: New York
Postal or Zip Code:: 13760

Citizenship Country:: United States

## **ASSIGNEE INFORMATION::**

ASSIGNEE:: International Business Machines Corporation

ASSIGNEE RESIDENCE:: Armonk, New York

# **CORRESPONDENCE INFORMATION:**

Correspondence Customer Number:: 000026681

### **APPLICATION INFORMATION::**

Title Line One:: SEMICONDUCTOR CHIP MODULE AND METHOD

Title Line Two:: OF MANUFACTURE OF SAME

Total Drawing Sheets:: 3
Formal Drawings?:: Yes
Application Type:: Utility

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### REPRESENTATIVE INFORMATION::

Representative Customer Number:: 000026681

## **CONTINUITY INFORMATION::**

This application is a:: Divisional of > Application One:: 10/254,414

Filing Date:: September 25, 2002

Patent Number::

## **PRIOR FOREIGN APPLICATIONS::**

Foreign Application One:: No

Filing Date:: Country::

**Priority Claimed::**